

SMD Schottky Barrier Diode



SMD Diodes Specialist

CDBU0230-N(Lead-free Device)

$I_o = 200 \text{ mA}$
 $V_R = 30 \text{ Volts}$

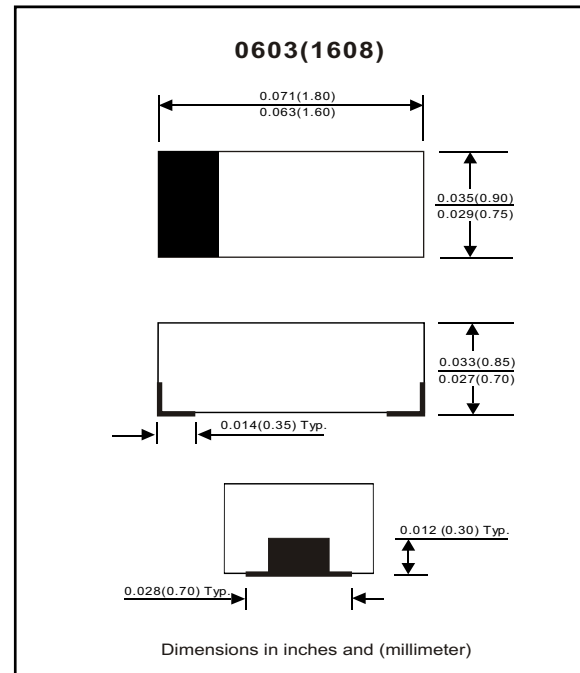


Features

- Designed for mounting on small surface.
- Extremely thin/leadless package.
- Low drop-down voltage.
- Majority carrier conduction.

Mechanical data

- Case: 0603 (1608) Standard package , molded plastic.
- Terminals: Gold plated, solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band
- Mounting position: Any.
- Weight: 0.003 gram (approx.).



Maximum Rating (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Repetitive peak reverse voltage		V_{RRM}			35	V
Reverse voltage		V_R			30	V
Average forward current		I_o			200	mA
Forward current,surge peak	8.3ms single halfsine-wave superimposed on rate load(JEDEC method)	I_{FSM}		2000		mA
Power Dissipation		P_D			150	mW
Storage temperature		T_{STG}	-40		+125	$^\circ\text{C}$
Junction temperature		T_j			+125	$^\circ\text{C}$

Electrical Characteristics (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F = 200 \text{ mADC}$	V_F			0.50	V
Reverse current	$V_R = 30 \text{ V}$	I_R			30	μA
Capacitance between terminals	$f = 1 \text{ MHz, and } 10\text{VDC reverse voltage}$	C_T		9		pF

RATING AND CHARACTERISTIC CURVES (CDBU0230-N)

Fig. 1 - Forward characteristics

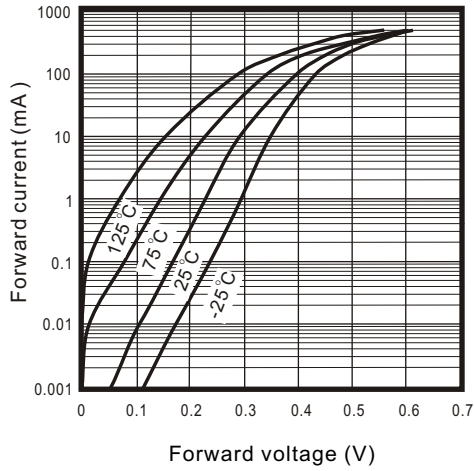


Fig. 2 - Reverse characteristics

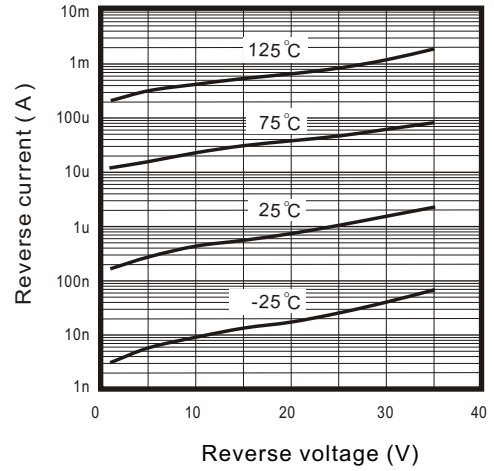


Fig. 3 - Capacitance between terminals characteristics

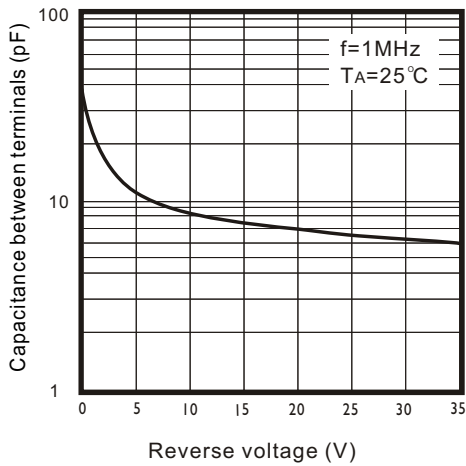


Fig. 4 - Current derating curve

